

CONTENTS

1

MECHANICAL DESIGN

1.1 Tools and Shop Processes	2	1.3.5 Rivets 26
1.1.1 Hand Tools	2	1.3.6 Pins 26
1.1.2 Machines for Making Holes	2	1.3.7 Retaining Rings 27
1.1.3 The Lathe	4	1.3.8 Adhesives 28
1.1.4 Milling Machines	7	1.4 Mechanical Drawing 28
1.1.5 Grinders	7	1.4.1 Drawing Tools 28
1.1.6 Tools for Working Sheet Metal	8	1.4.2 Basic Principles of Mechanical Drawing 28
1.1.7 Casting	9	1.4.3 Dimensions 32
1.2 Materials	10	1.4.4 Tolerances 34
1.2.1 Parameters to Specify Properties of Materials	10	1.4.5 From Design to Working Drawings 36
1.2.2 Heat Treating and Cold Working	12	1.5 Physical Principles of Mechanical Design 37
1.2.3 Iron and Steel	14	1.5.1 Bending of a Beam or Shaft 37
1.2.4 Nickel Alloys	14	1.5.2 Twisting of a Shaft 39
1.2.5 Copper and Copper Alloys	15	1.5.3 Stress Relief 39
1.2.6 Aluminum Alloys	16	1.5.4 Vibration of Beams and Shafts 40
1.2.7 Other Metals	16	1.5.5 Shaft Whirl and Vibration 41
1.2.8 Plastics	17	
1.2.9 Glasses and Ceramics	18	
1.3 Joining Materials	19	1.6 Constrained Motion 43
1.3.1 Soldering	19	1.6.1 Kinematic Design 43
1.3.2 Brazing	20	1.6.2 Plain Bearings 45
1.3.3 Welding	22	1.6.3 Ball Bearings 46
1.3.4 Threaded Fasteners	23	1.6.4 Linear-Motion Bearings 48
		1.6.5 Springs 48

Cited References	50
General References	50
Manufacturers and Suppliers	51

2

WORKING WITH GLASS

2.1 Properties of Glasses	55
2.1.1 Chemical Composition and Chemical Properties of Some Laboratory Glasses	55
2.1.2 Thermal Properties of Laboratory Glasses	56
2.1.3 Optical Properties of Laboratory Glassware	57
2.1.4 Mechanical Properties of Glass	57
2.2 Laboratory Components Available in Glass	58
2.2.1 Tubing and Rod	58
2.2.2 Demountable Joints	58
2.2.3 Valves and Stopcocks	59
2.2.4 Graded Glass Seals and Glass-to-Metal Seals	60
2.3 Laboratory Glassblowing Skills	61
2.3.1 The Glassblower's Tools	61
2.3.2 Cutting Glass Tubing	62
2.3.3 Pulling Points	63
2.3.4 Sealing off Tubing: The Test-Tube End	64
2.3.5 Making a T-Seal	66
2.3.6 Making a Straight Seal	66
2.3.7 Making a Ring Seal	68
2.3.8 Bending Glass Tubing	69
2.3.9 Annealing	70
2.3.10 Sealing Glass to Metal	70
2.3.11 Grinding and Drilling Glass	72
Cited References	73
General References	73
Manufacturers and Suppliers	73

3

VACUUM TECHNOLOGY

3.1 Gases	75
3.1.1 The Nature of the Residual Gases in a Vacuum System	75
3.1.2 Kinetic Theory	76
3.1.3 Surface Collisions	77
3.1.4 Bulk Behavior versus Molecular Behavior	77
3.2 Gas Flow	77
3.2.1 Parameters for Specifying Gas Flow	77
3.2.2 Network Equations	78
3.2.3 The Master Equation	78
3.2.4 Conductance Formulae	79
3.2.5 Pumpdown Time	79
3.2.6 Outgassing	80
3.3 Pressure Measurement	80
3.3.1 Mechanical Gauges	80
3.3.2 Thermal-Conductivity Gauges	82
3.3.3 Ionization Gauges	82
3.3.4 Mass Spectrometers	83
3.4 Vacuum Pumps	83
3.4.1 Mechanical Pumps	83
3.4.2 Vapor Diffusion Pumps	87
3.4.3 Sorption Pumps, Getter Pumps, Cryopumps, and Ion Pumps	88
3.5 Vacuum Hardware	90
3.5.1 Materials	90
3.5.2 Demountable Vacuum Connections	92
3.5.3 Valves	94
3.5.4 Mechanical Motion in the Vacuum System	94
3.5.5 Traps and Baffles	97
3.5.6 Molecular Beams and Gas Jets	99
3.5.7 Electronics and Electricity <i>in Vacuo</i>	102

3.6	Vacuum-System Design and Construction 103	4.4	Optical Materials 182
3.6.1	Some Typical Vacuum Systems 103	4.4.1	Materials for Windows, Lenses, and Prisms 182
3.6.2	The Construction of Metal Vacuum Apparatus 109	4.4.2	Materials for Mirrors and Diffraction Gratings 191
3.6.3	Surface Preparation 112		
3.6.4	Leak Detection 113		
3.6.5	Ultrahigh Vacuum 113	4.5	Optical Sources 193
	Cited References 114	4.5.1	Coherence 193
	General References 115	4.5.2	Radiometry: Units and Definitions 194
	Manufacturers and Suppliers 115	4.5.3	Photometry 195
		4.5.4	Line Sources 195
		4.5.5	Continuum Sources 196

4

OPTICS

4.1	Optical Terminology 119	4.6	Lasers 206
		4.6.1	General Principles of Laser Operation 215
4.2	Analysis of Optical Systems 121	4.6.2	General Features of Laser Design 216
4.2.1	Simple Reflection and Refraction Analysis 121	4.6.3	Specific Laser Systems 220
4.2.2	Paraxial-Ray Analysis 123	4.6.4	Laser Radiation 227
4.2.3	The Use of Impedances in Optics 131	4.6.5	Optical Modulators 228
4.2.4	Gaussian Beams 135	4.6.6	How to Work Safely with Light Sources 231
4.3	Optical Components 138	4.7	Optical Dispersing Instruments 233
4.3.1	Mirrors 138	4.7.1	Comparison of Prism and Grating Spectrometers 236
4.3.2	Windows 142	4.7.2	Design of Spectrometers and Spectrographs 238
4.3.3	Lenses and Lens Systems 143	4.7.3	Calibration of Spectrometers and Spectrographs 241
4.3.4	Prisms 149	4.7.4	Fabry-Perot Interferometers and Etalons 242
4.3.5	Diffraction Gratings 154	4.7.5	Design Considerations for Fabry-Perot Systems 251
4.3.6	Polarizers 157	4.7.6	Double-Beam Interferometers 251
4.3.7	Filters 164		
4.3.8	Fiber Optics 168		
4.3.9	Devices for Positional and Orientational Adjustment of Optical Components 170	4.8	Detectors 256
4.3.10	Optical Tables and Vibration Isolation 175	4.8.1	Figures of Merit for Detectors 257
4.3.11	Alignment of Optical Systems 176	4.8.2	Photoemissive Detectors 260
4.3.12	Mounting Optical Components 176	4.8.3	Photoconductive Detectors 271
4.3.13	Cleaning Optical Components 179	4.8.4	Photovoltaic Detectors (Photodiodes) 276

- 4.8.5 Detector Arrays 280
- 4.8.6 Thermal Detectors 280
- 4.8.7 Detector Calibration 285

Cited References 286

General References 290

Manufacturers and Suppliers 292

- 5.5 **Mass Analyzers** 332
 - 5.5.1 Magnetic Sector Analyzers 333
 - 5.5.2 Wien Filter 333
 - 5.5.3 Dynamic Mass Spectrometers 334

5 CHARGED-PARTICLE OPTICS

- 5.1 Basic Concepts of Charged-Particle Optics** 305
 - 5.1.1 Brightness 305
 - 5.1.2 Snell's Law 306
 - 5.1.3 The Helmholtz-Lagrange Law 306
 - 5.1.4 Vignetting 307

- 5.2 Electrostatic Lenses** 308

- 5.2.1 Geometrical Optics of Thick Lenses** 308
- 5.2.2 Cylinder Lenses** 310
- 5.2.3 Aperture Lenses** 312
- 5.2.4 Matrix Methods** 313
- 5.2.5 Aberrations** 314
- 5.2.6 Lens Design Example** 318

- 5.3 Charged-Particle Sources** 319

- 5.3.1 Electron Guns** 320
- 5.3.2 Electron-Gun Design Example** 321
- 5.3.3 Ion Sources** 323

- 5.4 Energy Analyzers** 325

- 5.4.1 Parallel-Plate Analyzers** 326
- 5.4.2 Cylindrical Analyzers** 327
- 5.4.3 Spherical Analyzers** 329
- 5.4.4 Preretardation** 330
- 5.4.5 The Energy-Add Lens** 330
- 5.4.6 Fringing-Field Correction** 332

- 5.6 Electron- and Ion-Beam Devices: Construction** 335
 - 5.6.1 Vacuum Requirements 335
 - 5.6.2 Materials 335
 - 5.6.3 Lens and Lens-Mount Design 336
 - 5.6.4 Charged-Particle Detection 337
 - 5.6.5 Magnetic-Field Control 341

Cited References 343

Manufacturers and Suppliers 344

6 ELECTRONICS

- 6.1 Preliminaries** 346
 - 6.1.1 Circuit Theory 346
 - 6.1.2 Circuit Analysis 348
 - 6.1.3 High-Pass and Low-Pass Circuits 352
 - 6.1.4 Resonant Circuits 354
 - 6.1.5 The Laplace-Transform Method 356
 - 6.1.6 RLC Circuits 359
 - 6.1.7 Transient Response of Resonant Circuits 360
 - 6.1.8 Transformers and Mutual Inductance 361
 - 6.1.9 Compensation 362
 - 6.1.10 Filters 363

- 6.2 Passive Components** 363

- 6.2.1 Fixed Resistors and Capacitors** 364
- 6.2.2 Variable Resistors** 365
- 6.2.3 Transmission Lines** 367
- 6.2.4 Coaxial Connectors** 378
- 6.2.5 Relays** 379

6.3 Active Components	382	6.7.5	Multiple Signal Sources: Data Loggers
6.3.1 Diodes	382	447	
6.3.2 Transistors	385	6.7.6	Standardized Data-Acquisition Systems
6.3.3 Field-Effect Transistors	390	447	
6.3.4 Silicon Controlled Rectifiers	392	6.7.7	Personal-Computer Control of Experiments
6.3.5 Unijunction Transistors	394	452	
6.3.6 Thyratrons	395		
6.4 Amplifiers and Pulse Electronics	395	6.8 Extraction of Signal from Noise	458
6.4.1 Definition of Terms	395	6.8.1	Signal-to-Noise Ratio
6.4.2 General Transistor-Amplifier Operating Principles	398	6.8.2	Optimizing the Signal-to-Noise Ratio
6.4.3 Operational-Amplifier Circuit Analysis	402	6.8.3	The Lock-In Amplifier and Gated Integrator or Boxcar
6.4.4 Instrumentation and Isolation Amplifiers	406	6.8.4	Signal Averaging
6.4.5 Stability and Oscillators	408	6.8.5	Waveform Recovery
6.4.6 Detecting and Processing Pulses	409		
6.5 Power Supplies	416	6.9 Grounds and Grounding	463
6.5.1 Power-Supply Specifications	416	6.9.1	Electrical Grounds and Safety
6.5.2 Regulator Circuits and Programmable Power Supplies	417	6.9.2	Electrical Pickup: Capacitive Effects
		6.9.3	Electrical Pickup: Inductive Effects
		6.9.4	Electromagnetic Interference and RFI
		6.9.5	Power-Line-Coupled Noise
		6.9.6	Ground Loops
6.6 Digital Electronics	420	6.10 Hardware and Construction	470
6.6.1 Binary Counting	420	6.10.1	Circuit Diagrams
6.6.2 Elementary Functions	421	6.10.2	Component Selection and Construction Techniques
6.6.3 Boolean Algebra	421	6.10.3	Printed Circuit Boards
6.6.4 Arithmetic Units	423	6.10.4	Wire Wrap™ Boards
6.6.5 Data Units	423	6.10.5	Wires and Cables
6.6.6 Dynamic Systems	423	6.10.6	Connectors
6.6.7 Digital-to-Analog Conversion	426		
6.6.8 Memories	430		
6.6.9 Logic and Function	432		
6.6.10 Implementing Logic Functions	436	6.11 Troubleshooting	490
		6.11.1	General Procedures
		6.11.2	Identifying Parts
6.7 Data Acquisition	441	Cited References	495
6.7.1 Voltage Levels and Timing	441	General References	495
6.7.2 Format	442	Manufacturers and Suppliers	497
6.7.3 System Overhead	443		
6.7.4 Analog Input Signals	444		

**Appendix to Chapter 6: Assembly of
Coaxial Connectors 502**

- 7.2 The Control of Temperature 517**
7.2.1 Temperature Control at Fixed Temperatures 517
7.2.2 Temperature Control at Variable Temperatures 519

**7 MEASUREMENT AND
CONTROL OF TEMPERATURE****7.1 The Measurement of Temperature 510**

- 7.1.1 Expansion Thermometers 510
7.1.2 Thermocouples 511
7.1.3 Resistance Thermometers 514
7.1.4 Quartz Thermometers 516
7.1.5 Comparison of Thermometers 516
7.1.6 Thermometer Calibration 517

- Cited References 525**
General References 526
Manufacturers and Suppliers 526

**APPENDIX: Recommended Values of
Physical Constants and Conversion
Factors 529****INDEX 531**

